

Docket 150.00720101

DECLARATION

We, Chad A. Cobbley, Tongbi Jiang, and Edward A. Schrock, declare that: (1) our respective citizenships and mailing addresses are indicated below; (2) we have reviewed and understand the contents of the specification identified below, including the claims, as amended by any amendment specifically referred to herein, (3) we believe that we are the original, first, and joint inventors of the subject matter in

ADHESIVE COMPOSITION AND METHODS FOR USE IN PACKAGING APPLICATIONS

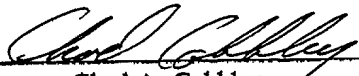
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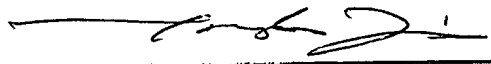
Serial No.: Unassigned


described and claimed therein and for which a patent is sought; and (4) we hereby acknowledge our duty to disclose to the Patent and Trademark Office all information known to us to be material to the patentability as defined in Title 37, Code of Federal Regulations, §1.56.*

The undersigned declare further that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Wherefore, we pray that Letters Patent be granted to us for the invention described and claimed in the specification identified above and we hereby subscribe our names to the foregoing specification and claims, and Declaration, on the date indicated below.

 4/22/98
Name Chad A. Cobbley Date
Citizenship: USA
Address: 608 Boise Hill Drive, Boise, ID 83702

 4-22-98
Name Tongbi Jiang Date
Citizenship: Peoples Republic of China
Address: 12036 West Patrlna Drive, Boise, ID 83713

 4-22-98
Name Edward A. Schrock Date
Citizenship: USA
Address: 3188 Whitman, Boise, ID 83716

*§ 1.56 Duty to disclose information material to patentability.

*Title 37, Code of Federal Regulations, §1.56 is reproduced on the attached page.

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(a) A patent by its very nature is affected with a public interest. The public interest is best served, and the most effective patent examination occurs when, at the time an application is being examined, the Office is aware of and evaluates the teachings of all information material to patentability. Each individual associated with the filing and prosecution of a patent application has a duty of candor and good faith in dealing with the Office, which includes a duty to disclose to the Office all information known to that individual to be material to patentability as defined in this section. The duty to disclose information exists with respect to each pending claim until the claim is cancelled or withdrawn from consideration, or the application becomes abandoned. Information material to the patentability of a claim that is cancelled or withdrawn from consideration need not be submitted if the information is not material to the patentability of any claim remaining under consideration in the application. There is no duty to submit information which is not material to the patentability of any existing claim. The duty to disclose all information known to be material to patentability is deemed to be satisfied if all information known to be material to patentability of any claim issued in a patent was cited by the Office or submitted to the Office in the manner prescribed by §§1.97(b)-(d) and 1.98. However, no patent will be granted on an application in connection with which fraud on the Office was practiced or attempted or the duty of disclosure was violated through bad faith or intentional misconduct. The Office encourages applicants to carefully examine:

- (1) Prior art cited in search reports of a foreign patent office in a counterpart application, and
- (2) The closest information over which individuals associated with the filing or prosecution of a patent application believe any pending claim patentably defines, to make sure that any material information contained therein is disclosed to the Office.

(b) Under this section, information is material to patentability when it is not cumulative to information already of record or being made of record in the application, and

- (1) It establishes, by itself or in combination with other information, a prima facie case of unpatentability of a claim; or
- (2) It refutes, or is inconsistent with, a position the applicant takes in:
 - (i) Opposing an argument of unpatentability relied on by the Office, or
 - (ii) Asserting an argument of patentability.

A prima facie case of unpatentability is established when the information compels a conclusion that a claim is unpatentable under the preponderance of evidence, burden-of-proof standard, giving each term in the claim its broadest reasonable construction consistent with the specification, and before any consideration is given to evidence which may be submitted in an attempt to establish a contrary conclusion of patentability.

(c) Individuals associated with the filing or prosecution of a patent application within the meaning of this section are:

- (1) Each inventor named in the application;
- (2) Each attorney or agent who prepares or prosecutes the application; and
- (3) Every other person who is substantively involved in the preparation or prosecution of the application and who is associated with the inventor, with the assignee or with anyone to whom there is an obligation to assign the application.

(d) Individuals other than the attorney, agent or inventor may comply with this section by disclosing information to the attorney, agent, or inventor.

ASSIGNMENT

Whereas we, Chad A. Cobbley, Tongbi Jiang, and Edward A. Schrock, with residences and citizenships as indicated below; have made an invention in

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Filed: Even Date Herewith

Serial No.: Not Assigned

and executed an application for Letters Patent of the United States of America based thereon;

Now, therefore, for good and valuable consideration, receipt of which is acknowledged, we have individually and jointly agreed to assign and transfer and do hereby assign and transfer unto Micron Technology, Inc. ("Company"), a corporation of Boise, Idaho, having its principal office at 8000 South Federal Way, Boise, Idaho 83707, its successors and assigns, the entire right, title, and interest in and to said invention and application, and in and to any division or continuation (in whole or in part) of said application, and in and to any and all improvements in said invention made by us or any of us or made jointly with others (provided any such improvement is made during, or within one year after the termination of, the employment by the Company of whichever of us, solely or jointly with one or more others, has made the same), and in and to any and all Letters Patent, reexaminations, reissues, or extensions thereof, of the United States of America and countries foreign thereto (including the right to apply for Letters Patent, Utility Models, or Inventors' Certificates in foreign countries in its own name and to claim any priority rights for such foreign applications to which such applications are entitled under international conventions, treaties, or otherwise), which have been or may be granted thereon or on any divisional, continuation (in whole or in part), renewal, reexamination, reissue, or other or further application based in whole or in part upon said invention or improvements thereon, to be held and enjoyed as fully and exclusively as they would have been by us or any of us had this assignment and transfer not been made;

We do further agree for ourselves and for our heirs, executors, and administrators, to execute and deliver without further consideration any further applications, assignments, and documents, and to perform such other acts as we lawfully may, that may be deemed necessary by the Company, its successors, assigns, and nominees, fully to secure its right, title, and interest as aforesaid and to obtain or maintain Letters Patent, Utility Models, or Inventors' Certificates in any and all countries;

And we do hereby authorize and request the Commissioner of Patents to issue any and all Letters Patent which may be granted upon any of said applications, to Micron Technology, Inc. as the assignee of the entire right, title, and interest therein.

In witness whereof, we have hereunto signed our names on the days and years set forth below.

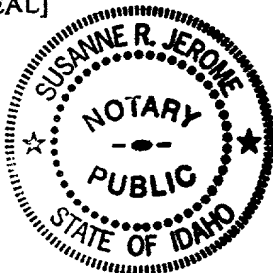
Name: Chad A. Cobbley
Residence: Boise, Idaho
Citizenship: USA
Address: 608 Boise Hill Drive, Boise, ID 83702

STATE OF Idaho)
) ss.
COUNTY OF Ada)

On this 22nd day of April 1998 before me personally appeared Chad A. Cobbley to me known to be the person described in and who executed the foregoing instrument, and he executed the same for the uses and purposes therein set forth.

[SEAL]

Susanne Blume
Notary Public



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ASSIGNMENT

Chad A. Cobbley, Tongbi Jiang, and Edward A. Schrock

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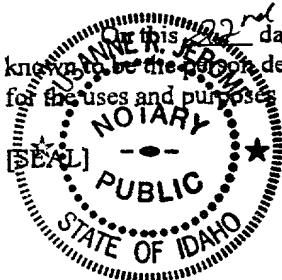
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4-22-98

 Name Tongbi Jiang Date
 Residence: Boise, Idaho
 Citizenship: Peoples Republic of China
 Address: 12036 West Patrina Drive, Boise, ID 83713

STATE OF IDAHO)
)ss.
 COUNTY OF Ada)

On this 22nd day of April 1998 before me personally appeared Tongbi Jiang to me known to be the person described in and who executed the foregoing instrument, and he executed the same for the uses and purposes therein set forth.



 Notary Public

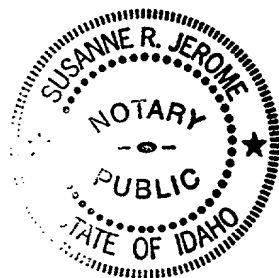
4-22-98

 Name Edward A. Schrock Date
 Residence: Boise, Idaho
 Citizenship: USA
 Address: 3188 Whitman, Boise, ID 83716

STATE OF IDAHO)
)ss.
 COUNTY OF Ada)

On this 22nd day of April 1998 before me personally appeared Edward A. Schrock to me known to be the person described in and who executed the foregoing instrument, and he executed the same for the uses and purposes therein set forth.

[SEAL]



 Notary Public

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